

**Silicon Diffused Power Transistor****BUT12AI****GENERAL DESCRIPTION**

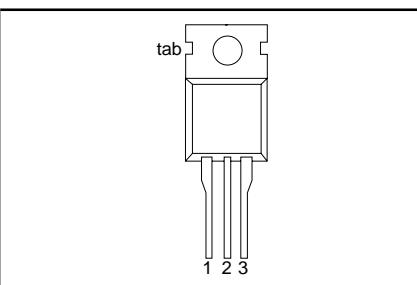
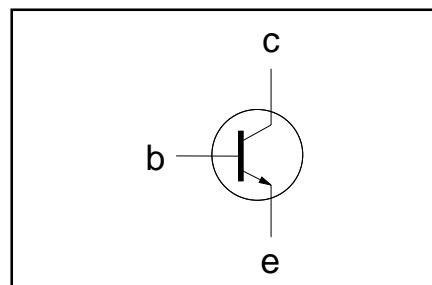
Improved high-voltage, high-speed glass-passivated npn power transistor in a TO220AB envelope specially suited for use in overhead/high frequency lighting ballast applications and converters, inverters, switching regulators, motor control systems, etc.

**QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$V_{CESM}$	Collector-emitter voltage peak value	$V_{BE} = 0 \text{ V}$	-	1000	V
$V_{CEO}$	Collector-emitter voltage (open base)		-	450	V
$I_C$	Collector current (DC)		-	8	A
$I_{CM}$	Collector current peak value		-	20	A
$P_{tot}$	Total power dissipation		-	110	W
$V_{CEsat}$	Collector-emitter saturation voltage	$T_{hs} \leq 25 \text{ }^\circ\text{C}$	-	1.5	V
$I_{Csat}$	Collector saturation current	$I_C = 5 \text{ A}; I_B = 0.86 \text{ A}$	5	-	A
$t_f$	Inductive fall time	$I_{Con} = 5 \text{ A}; I_{Bon} = 1.0 \text{ A}; T_j \leq 100 \text{ }^\circ\text{C}$		300	ns

**PINNING - TO220AB**

PIN	DESCRIPTION
1	base
2	collector
3	emitter
tab	collector

**PIN CONFIGURATION****SYMBOL****LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CESM}$	Collector-emitter voltage peak value	$V_{BE} = 0 \text{ V}$	-	1000	V
$V_{CEO}$	Collector-emitter voltage (open base)		-	450	V
$I_C$	Collector current (DC)		-	8	A
$I_{CM}$	Collector current peak value		-	20	A
$I_B$	Base current (DC)		-	4	A
$I_{BM}$	Base current peak value		-	6	A
$P_{tot}$	Total power dissipation	$T_{hs} \leq 25 \text{ }^\circ\text{C}$	-	110	W
$T_{stg}$	Storage temperature		-65	150	°C
$T_j$	Junction temperature		-	150	°C

**THERMAL RESISTANCES**

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th j-hs}$	Junction to heatsink	with heatsink compound	-	1.15	K/W
$R_{th j-a}$	Junction to ambient	in free air	-	60	K/W

## Silicon Diffused Power Transistor

BUT12AI

## STATIC CHARACTERISTICS

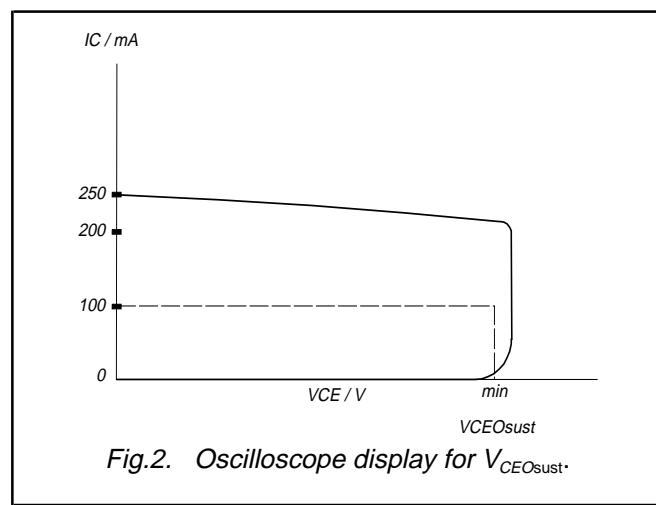
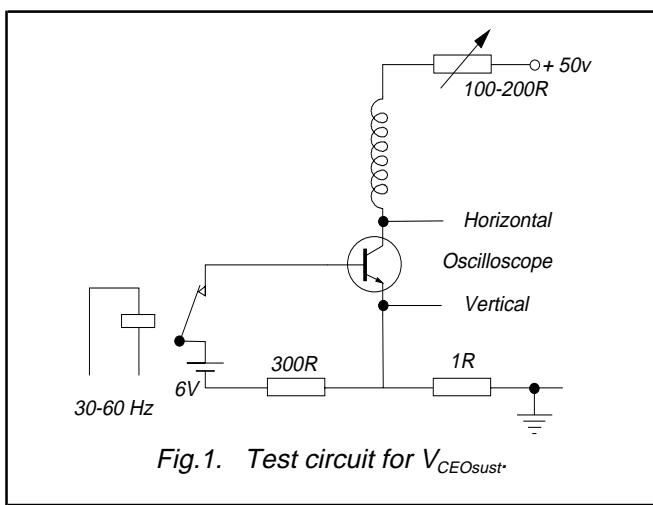
 $T_{hs} = 25^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{CES}$	Collector cut-off current <sup>1</sup>	$V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax}$	-	-	1.0	mA
$I_{CES}$		$V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax}$	-	-	3.0	mA
$I_{EBO}$	Emitter cut-off current	$T_j = 125^\circ\text{C}$	-	-	10	mA
$V_{CEO_sust}$	Collector-emitter sustaining voltage	$V_{EB} = 9 \text{ V}; I_C = 0 \text{ A}$ $I_B = 0 \text{ A}; I_C = 100 \text{ mA}; L = 25 \text{ mH}$	450	-	-	V
$V_{CEsat}$	Collector-emitter saturation voltages	$I_C = 5 \text{ A}; I_B = 0.86 \text{ A}$	-	-	1.5	V
$V_{BEsat}$	Base-emitter saturation voltage	$I_C = 5 \text{ A}; I_B = 0.86 \text{ A}$	-	-	1.3	V
$h_{FE}$	DC current gain	$I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$	10	18	35	
$h_{FE}$		$I_C = 1.0 \text{ A}; V_{CE} = 5 \text{ V}$	14	20	35	
$h_{FEsat}$		$I_C = 5.0 \text{ A}; V_{CE} = 1.5 \text{ V}$	5.8	10	12.5	

## DYNAMIC CHARACTERISTICS

 $T_{hs} = 25^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$t_{on}$	Switching times (resistive load)	$I_{Con} = 5 \text{ A}; I_{Bon} = -I_{Boff} = 1.0 \text{ A}$	-	1.0	$\mu\text{s}$
$t_s$	Turn-on time		-	4.0	$\mu\text{s}$
$t_f$	Turn-off storage time		-	0.8	$\mu\text{s}$
$t_s$	Turn-off fall time				
$t_f$	Switching times (inductive load)	$I_{Con} = 5 \text{ A}; I_{Bon} = 1.0 \text{ A}; L_B = 1 \mu\text{H}$ $-V_{BB} = 5 \text{ V}; T_j = 100^\circ\text{C}$	1.9	2.5	$\mu\text{s}$
$t_s$	Turn-off storage time		150	300	$\mu\text{s}$
$t_f$	Turn-off fall time				ns



<sup>1</sup> Measured with half sine-wave voltage (curve tracer).

## Silicon Diffused Power Transistor

BUT12AI

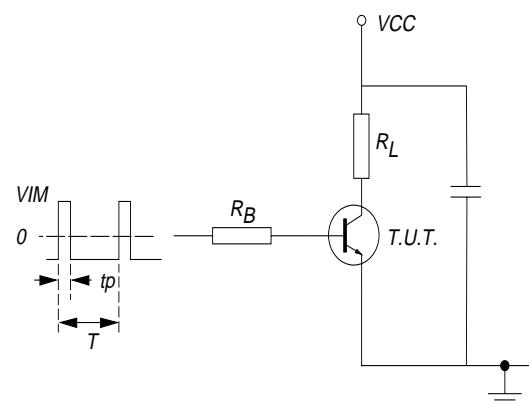


Fig.3. Test circuit resistive load.  $V_{IM} = -6$  to  $+8$  V  
 $V_{CC} = 250$  V;  $tp = 20 \mu s$ ;  $\delta = tp / T = 0.01$ .  
 $R_B$  and  $R_L$  calculated from  $I_{Con}$  and  $I_{Bon}$  requirements.

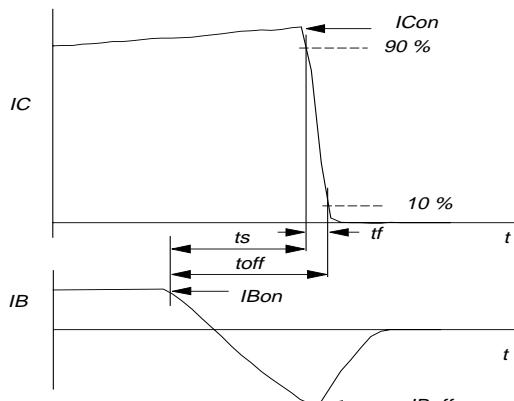


Fig.6. Switching times waveforms with inductive load.

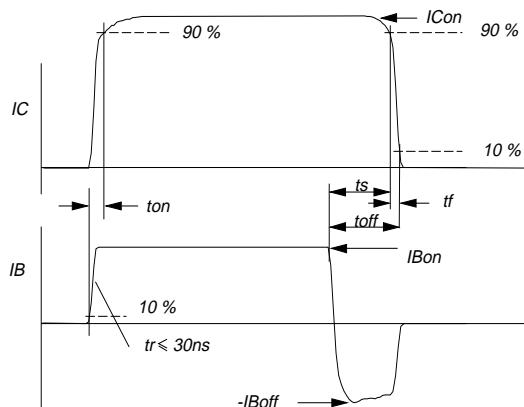


Fig.4. Switching times waveforms with resistive load.

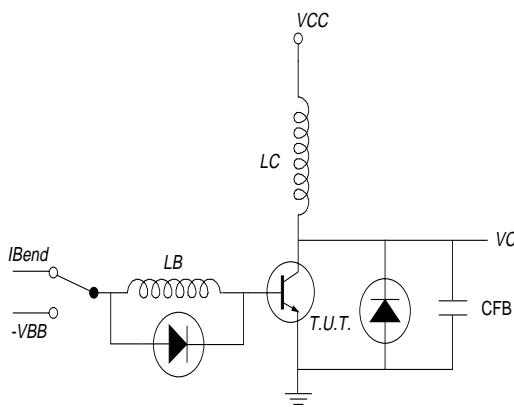


Fig.7. Test circuit RBSOA.  $V_{CC} = 150$  V;  $-V_{BB} = 5$  V  
 $L_C = 200 \mu H$ ;  $V_{CL} \leq 850$  V;  $L_B = 1 \mu H$

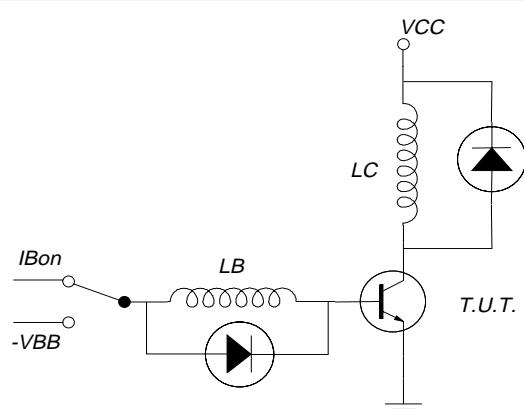


Fig.5. Test circuit inductive load.  
 $V_{CC} = 300$  V;  $-V_{BE} = 5$  V;  $L_B = 1 \mu H$

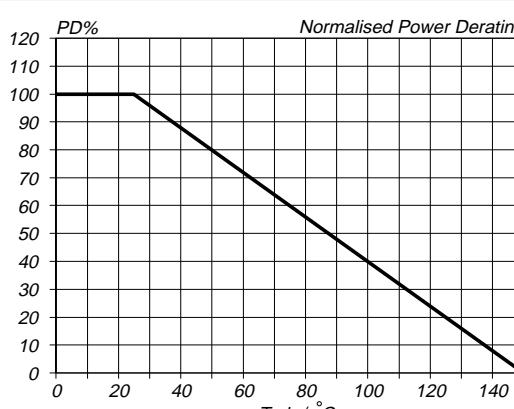


Fig.8. Normalised power dissipation.  
 $PD\% = 100 \cdot PD/PD_{25^\circ C} = f(T_{mb})$

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BUT12AI

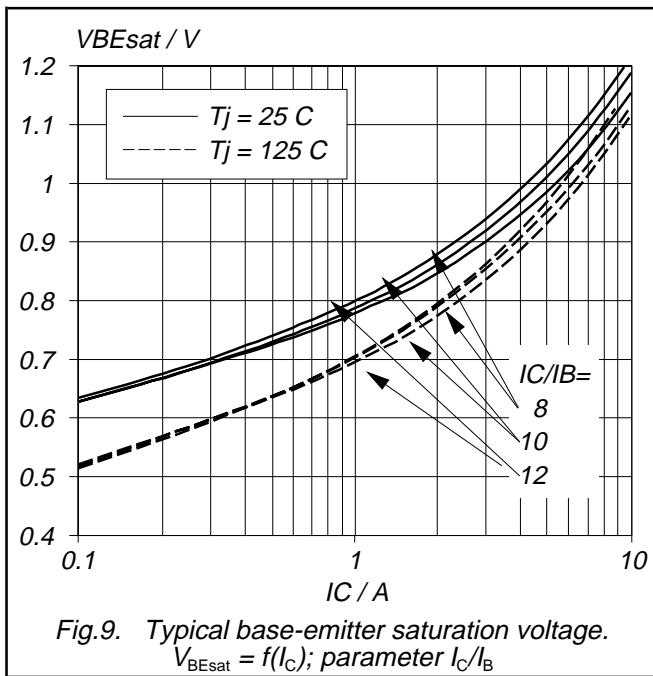


Fig.9. Typical base-emitter saturation voltage.  
 $V_{BEsat} = f(I_C)$ ; parameter  $I_C/I_B$

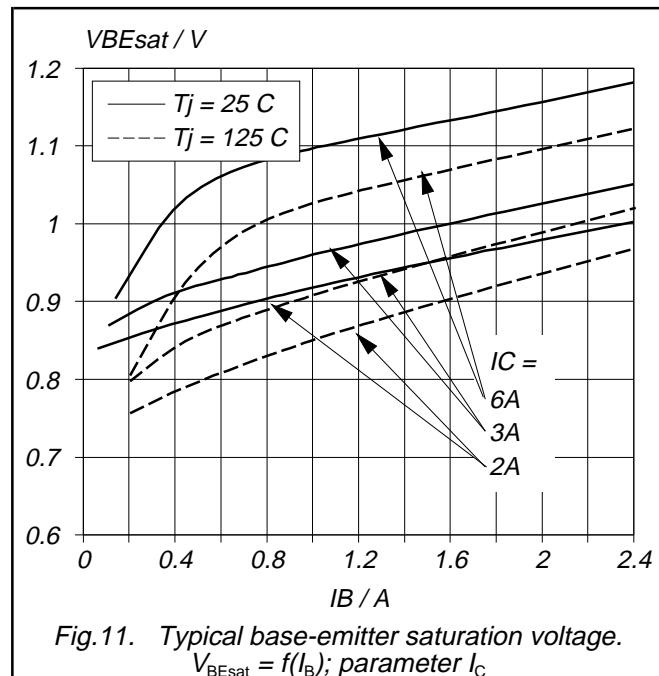


Fig.11. Typical base-emitter saturation voltage.  
 $V_{BEsat} = f(I_B)$ ; parameter  $I_C$

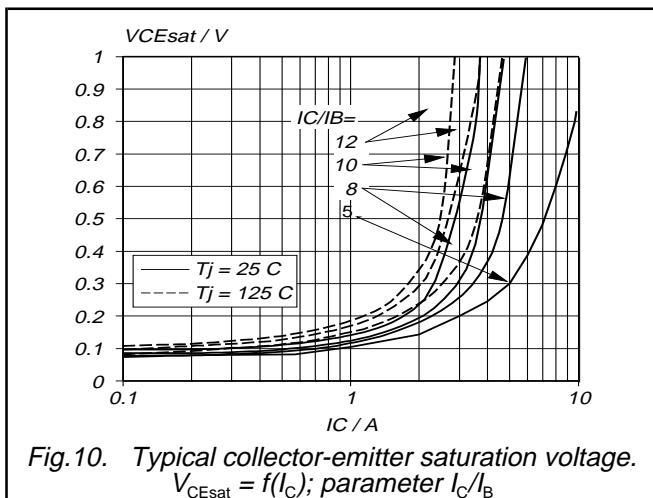


Fig.10. Typical collector-emitter saturation voltage.  
 $V_{CEsat} = f(I_C)$ ; parameter  $I_C/I_B$

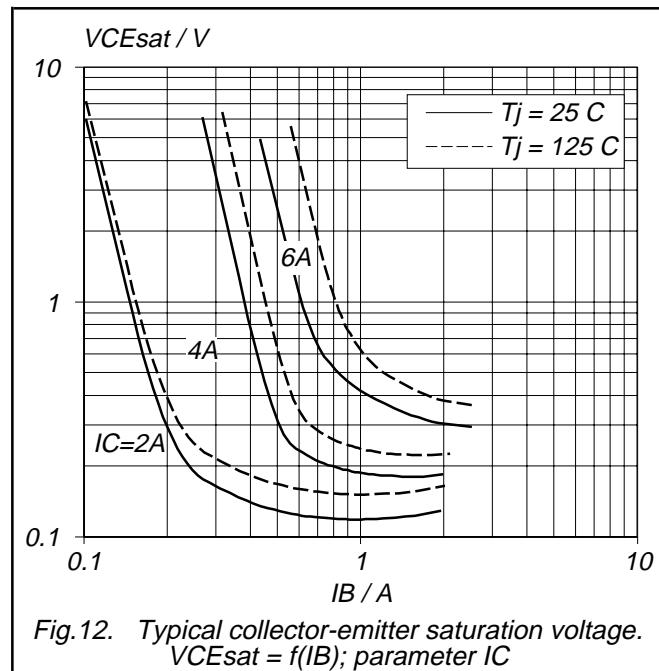
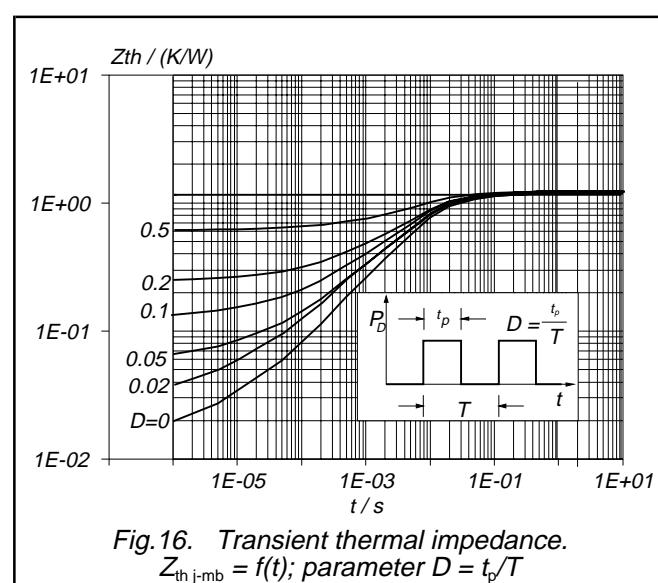
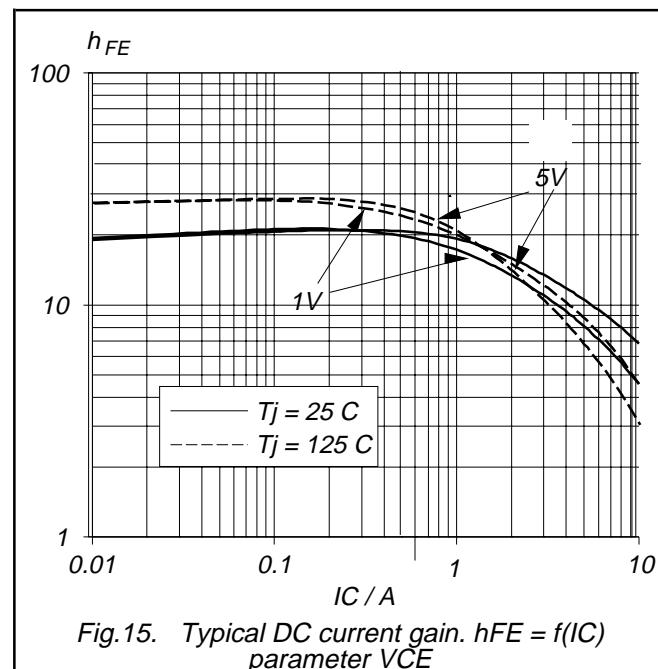
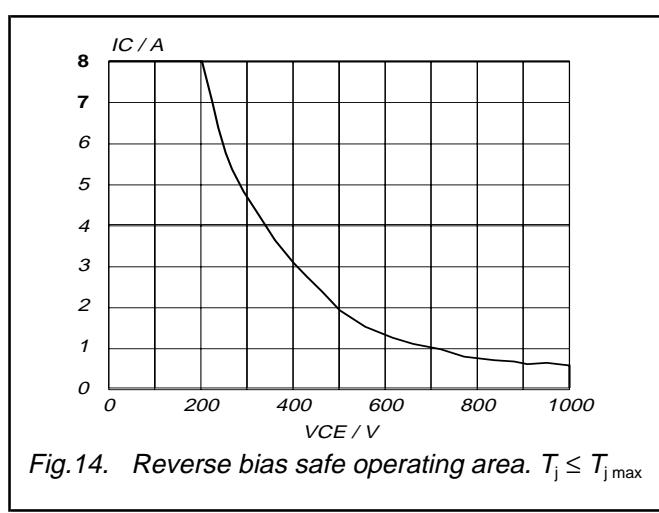
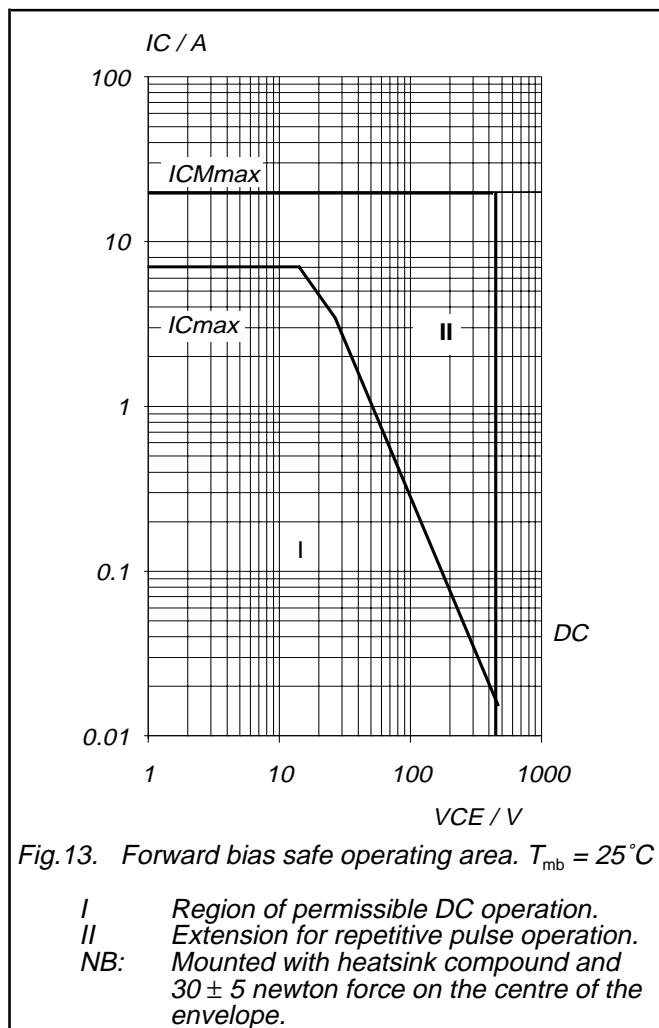


Fig.12. Typical collector-emitter saturation voltage.  
 $V_{CEsat} = f(I_B)$ ; parameter  $IC$

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BUT12AI

**MECHANICAL DATA***Dimensions in mm*

Net Mass: 2 g

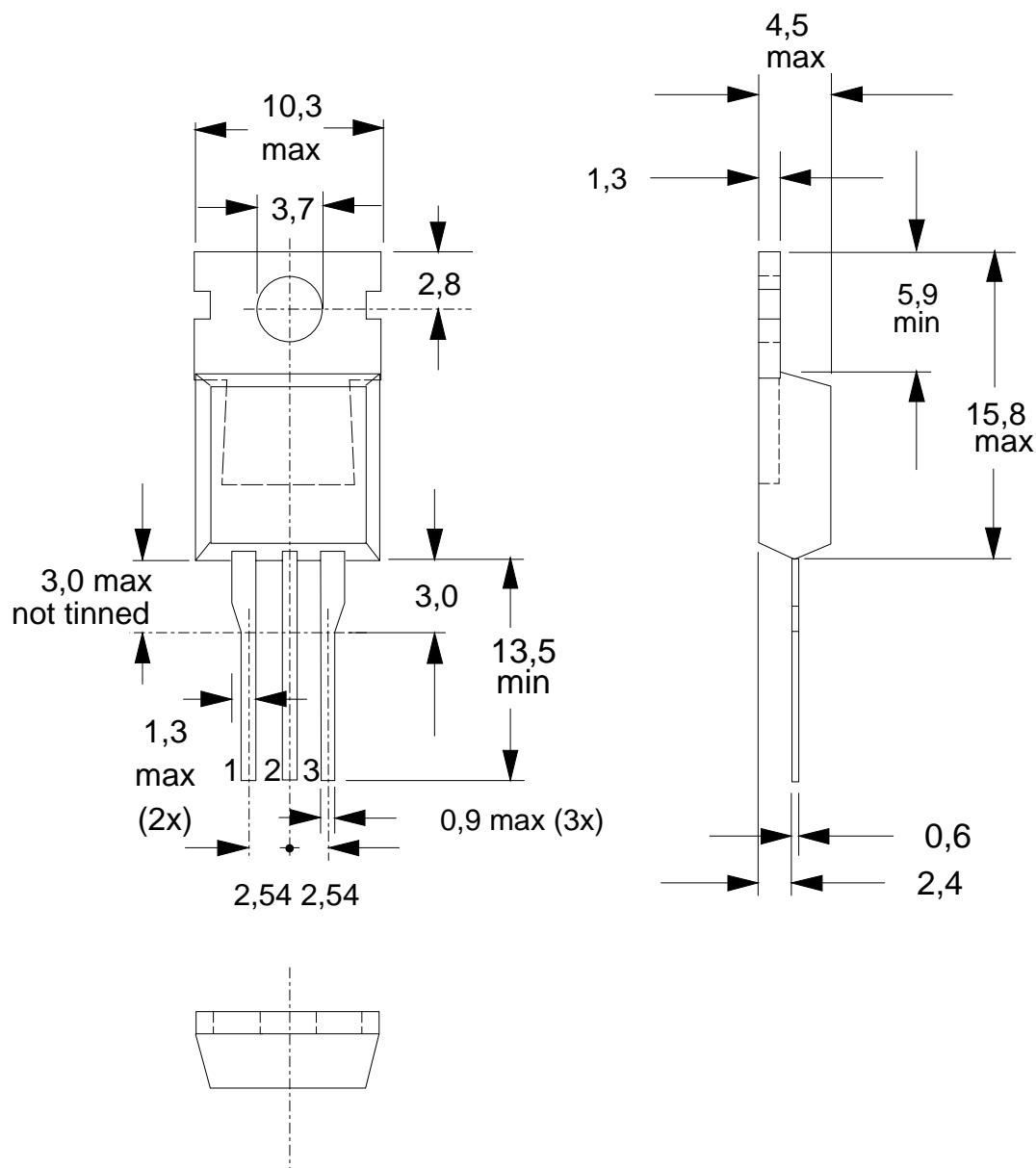


Fig.17. TO220AB; pin 2 connected to mounting base.

**Notes**

1. Refer to mounting instructions for TO220 envelopes.
2. Epoxy meets UL94 V0 at 1/8".

**Silicon Diffused Power Transistor****BUT12AI****DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	
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